



2026 Brian Michael Harper Memorial SCHOLARSHIP ANNOUNCEMENT

The Links, Incorporated is an international, not-for-profit corporation established in 1946, composed of accomplished women of African descent committed to friendship and service. With chapters across the United States and abroad, it continues to have a profound impact on communities through civic engagement, educational initiatives, and global outreach.

Buffalo (NY) Chapter of The Links, Incorporated announces the Brian Michael Harper Memorial Scholarship for high school graduates who will attend Cornell University by Fall 2026 or for high school graduates of Hutch Tech High School, both of which were Brian's alma maters. The scholarship is to continue his legacy of being a good citizen and having a positive impact on the people he met.

Criteria, which must be met by applicants, are as follows:

- High School Senior, graduating in May/June 2026 from Hutch Tech High School or a High School Senior, graduating in May/June 2026 who will be attending Cornell University.
- Evidence of good citizenship and community service.
- Minimum grade point Average of 85 (or the equivalent letter grade).

The Applicant must:

1. Complete the application.
2. **If you are a High School Senior:**
 - Write a personal statement explaining his/her interests, the need for the scholarship, and evidence of community activities/service to others.
 - Submit a letter of recommendation from a teacher, school counselor or principal.
 - Have his/her school counselor mail a copy of the official transcript by **April 24, 2026**, to the PO box shown below.
3. If selected as a finalist, be available for a virtual interview, which will be scheduled between **May 12 – May 13, 2026**.

The scholarship application, personal statement, letter of recommendation, and transcript must be received by the scholarship committee, addressed as follows and **postmarked** no later than **April 24, 2026**.

**Buffalo (NY) Chapter of The Links, Incorporated
c/o Scholarship (BMH) Committee
P.O. Box 1664
Buffalo, NY 14226**



2026 Brian Michael Harper Memorial Scholarship Application

Personal Information

Name _____	Birth Date _____	
Address _____		
City _____	Zip Code _____	Telephone _____
Email _____		
Parent or Guardian _____		
Address (if different from above) _____		
Annual Family Income _____		
Number in Family Living at Home _____	Number in College _____	

Education

Elementary School _____		
High School _____		
High School Major _____		
Rank in Class _____	SAT/ACT Scores _____	Overall Average _____

Additional Personal Information (Use additional paper if necessary)

Extra-Curricular & Community Activities (please List) _____

List any Prizes, Awards, Honors, etc., received _____

Hobbies, Skills, Talents _____

What are your future goals? _____

College

What college do you plan to attend?	_____
Courses/Majors Contemplated	_____
Please list anticipated annual college expenses:	
Tuition	_____
Books	_____
Room & Board	_____
Other	_____
Total	_____
List other scholarships, aid, grants, etc. applied for	_____
_____	_____
How did you learn about this scholarship opportunity?	_____
_____	_____

Applicant's Personal Statement:

Explain your interests, goals, future plans, need for this scholarship, and evidence of your community involvement/service should be included. Your personal statement may be submitted as an attachment with this application.

Please mail completed application, letter of recommendation, and school transcript by
April 24, 2026, to:

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c/o Scholarship (BMH) Committee
Box 1664
Buffalo, NY 14226**